

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ROBERT MERRIMAN	04/20/2015
HEEKOOK YANG	04/20/2015
SATISH KETKAR	04/17/2015
RICK H RAJAIE	04/27/2015
STEVEN ALVEY	04/21/2015
RECEIVING PARTY DATA	
Name:	LG CHEM, LTD.
Street Address:	128, YEOUI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14698376
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ATTORNEY DOCKET NUMBER:	CMT0271US
NAME OF SUBMITTER:	JOHN F BUCKERT
SIGNATURE:	/JohnFBuckert/
DATE SIGNED:	04/28/2015
Total Attachments: 5	
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ASSIGNMENT

WHEREAS We, **Robert Merriman of Shelby Township, MI** and **Heekook Yang of Troy, MI** and **Satish Ketkar of Troy, MI** and **Rick H. Rajaie of Rochester Hills, MI** and **Steven Alvey of Rochester Hills, MI** (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

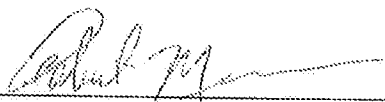
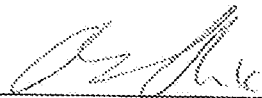
BATTERY PACK

for which we are about to file an application for Letters Patent of the United States;

AND WHEREAS, **LG Chem, Ltd.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea, having a place of business at **128, Yeoui-daero, Yeongdeungpo-Gu, Seoul, Republic of Korea 150-721**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 4/20/15

 _____ L.S.
 Robert Merriman
Date: 4/20/2015

 _____ L.S.
 Heekook Yang

Date: _____

 _____ L.S.
 Satish Ketkar

Date: _____

 _____ L.S.
 Rick H. Rajaie

Date: _____

 _____ L.S.
 Steven Alvey

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Date: _____ L.S.

Robert Merriman

Date: _____ L.S.

Heekook Yang

Date: April 17, 2015 L.S.


Satish Ketkar

Date: _____ L.S.

Rick H. Rajaie

Date: _____ L.S.

Steven Alvey

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: _____ L.S.
Robert Merriman

Date: _____ L.S.
Heekook Yang

Date: _____ L.S.
Satish Ketkar

Date: 04/27/2015 L.S.

Rick H. Rajaie

Date: _____ L.S.
Steven Alvey

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: _____ L.S.
Robert Merriman

Date: _____ L.S.
Heekook Yang

Date: _____ L.S.
Satish Ketkar

Date: _____ L.S.
Rick H. Rajaie

Date: 4/21/15 L.S.

Steven Alvey